

 $\pm \pm 4$

4PIN LSOP PHOTODARLINGTON PHOTOCOUPLER

Description

The KT1410 series consist of a photodarlington optically coupled to a gallium arsenide infrared-emitting diode in a 4 pin LSOP wide body package. Collector-emitter voltage is 300V. It features a high current transfer ratio, low coupling capacitance and high isolation voltage.

1. Anode

Schematic

1

2

- 2. Cathode
- 3. Emitter
- 4. Collector

Features

- 1. Pb free and RoHS compliant
- 2. Temperature range -55°C to 115°C
- 3. Opaque type, SMD low profile 4 lead package
- 4. High collector-emitter voltage (V_{CEO}: 300V)
- 5. High current transfer ratio

(CTR : Min.1000% at $I_F = 1mA, V_{CE} = 2V$)

- 6. High isolation voltage 5000Vrms
- 7. 8mm outer creepage distance
- 8. MSL class 1
- 9. Agency Approvals:
- UL Approved (No. E169586): UL1577
- c-UL Approved (No. E169586)
- VDE Approved (No. 40031267): DIN EN60747-5-5
- FIMKO Approved: EN62368-1, EN60601-1
- CQC Approved: GB8898-2011, GB4943.1-2011

Applications

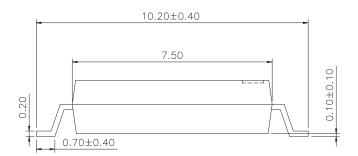
- · Telephone sets
- · Copiers, facsimiles
- Interfaces with various power supply circuits power distribution boards.
- Hybrid substrates which require high density mounting

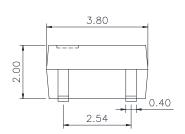
4PIN LSOP PHOTODARLINGTON PHOTOCOUPLER

Outside Dimension

Unit: mm







TOLERANCE: ±0.2mm

Device Marking



Notes:

cosmo

YWW Y: Year code / WW: Week code



4PIN LSOP PHOTODARLINGTON PHOTOCOUPLER

Absolute Maximum Ratings

(Ta=25°ℂ)

Parameter		Symbol	Rating	Unit	
Input	Forward current	lF	50	mA	
	Peak forward current	I FP	1	Α	
	Reverse voltage	VR	6	V	
	Power dissipation	P_{D}	70	mW	
	Collector-Emitter voltage	VCEO	300	V	
Output	Emitter-Collector voltage	VECO	0.1	V	
	Collector current	Ic	150	mA	
	Collector power dissipation	Pc	150	mW	
Total power dissipation		Ptot	170	mW	
Isolation voltage 1 minute		Viso	5000	Vrms	
Operating temperature		Topr	-55 to +115	$^{\circ}\!\mathbb{C}$	
Storage temperature		Tstg	-55 to +125	$^{\circ}\!\mathbb{C}$	
Soldering temperature 10 seconds		Tsol	260	$^{\circ}\!\mathbb{C}$	

Electro-optical Characteristics

(Ta=25°ℂ)

	Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
	Forward voltage	V _F	I _F =20mA	_	1.2	1.4	V
	Reverse current	I _R	V _R =4V	_	-	10	uA
	Terminal capacitance	Ct	V=0, f=1KH _Z	-	30	-	pF
Output	Collector dark current	I _{CEO}	VCE=200V, I _F =0	-	-	1	uA
	Collector-Emitter breakdown voltage	BV _{CEO}	Ic=0.1mA, I _F =0	300	ı	-	V
Transfer characteristics	Current transfer ratio	CTR	I _F =1mA, V _{CE} =2V	1000	-	-	%
	Collector-Emitter saturation voltage	V _{CE} (sat)	I _F =1mA, Ic=2mA	-	1	1.5	V
	Isolation resistance	Riso	DC500V, 40 to 60%RH	5x10 ¹⁰	10 ¹¹	-	Ω
	Floating capacitance	Cf	V=0, f=1MH _Z	-	0.6	1.0	pF
	Response time (Rise)	tr	\/aa=2\/ a=20mA D =1000	-	100	300	us
	Response time (Fall)	tf	Vcc=2V,lc=20mA,R _L =100Ω	_	20	100	us

4PIN LSOP PHOTODARLINGTON PHOTOCOUPLER

Fig.1 Current Transfer Ratio vs. Forward Current

Classification table of current transfer ratio is shown below.

CTR Rank	CTR (%)
KT1410	Min.1000

Ontent Lansfer Bafford

Forward Current I_F (mA)

Fig.2 Collector Power Dissipation vs. Ambient Temperature

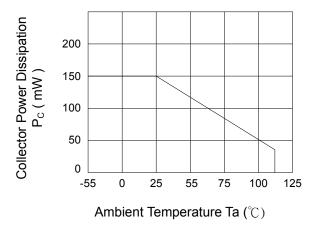


Fig.3 Collector Dark Current vs. Ambient Temperature

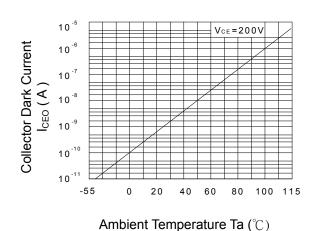


Fig.4 Forward Current vs. Ambient Temperature

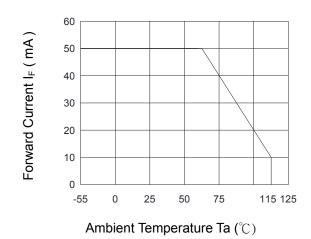
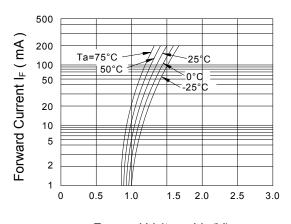


Fig.5 Forward Current vs. Forward Voltage



Forward Voltage V_F (V)

Cosmo Electronics Corp. Document No. 69P20003.7

http://www.cosmo-ic.com

4PIN LSOP PHOTODARLINGTON PHOTOCOUPLER

Fig.6 Collector Current vs. Collector-Emitter Voltage

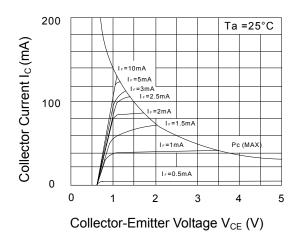


Fig.8 Collector-Emitter Saturation Voltage vs. Forward Current

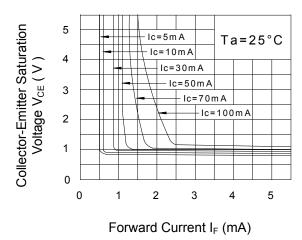


Fig.7 Relative Current Transfer Ratio vs. Ambient Temperature

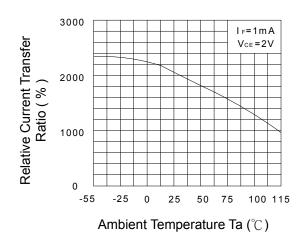
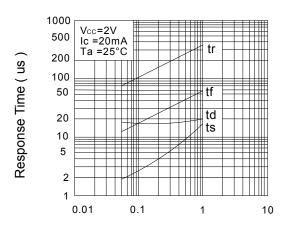


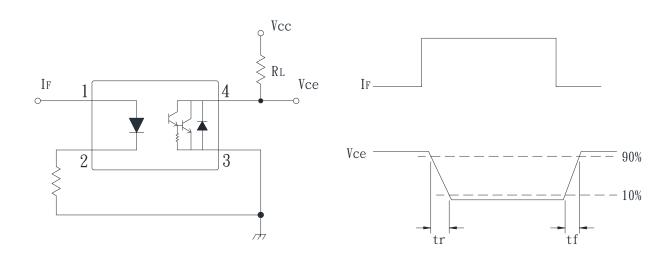
Fig.9 Response Time vs. Load Resistance



Load Resistance $R_L(K\Omega)$



• Test Circuit for Response Time





4PIN LSOP PHOTODARLINGTON PHOTOCOUPLER

Recommended Soldering Conditions

(a) Infrared reflow soldering:

■ Peak reflow soldering : 260°C or below (package surface temperature)

■ Time of peak reflow temperature : 10 sec
 ■ Time of temperature higher than 230°C : 30-60 sec
 ■ Time to preheat temperature from 180~190°C : 60-120 sec

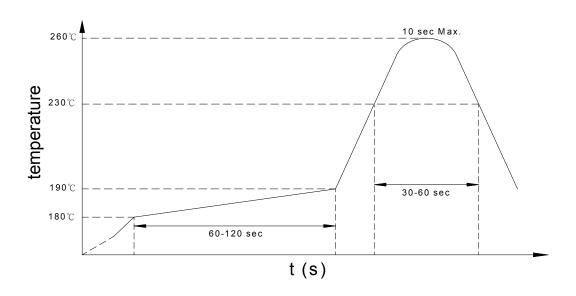
■ Time(s) of reflow: Two

■ Flux : Rosin flux containing small amount of chlorine (The

flux with a maximum chlorine content of 0.2 Wt% is

recommended.)

Recommended Temperature Profile of Infrared Reflow



(b) Wave soldering:

■ Temperature : 260°C or below (molten solder temperature)

■ Time: 10 seconds or less

■ Preheating conditions : 120°C or below (package surface temperature)

■ Time(s) of reflow : One

■ Flux: Rosin flux containing small amount of chlorine (The flux with a maximum

chlorine content of 0.2 Wt% is recommended.)

(c) Cautions:

■ Fluxes: Avoid removing the residual flux with freon-based and chlorine-based

cleaning solvent.

Avoid shorting between portion of frame and leads.



Numbering System

KT1410 (Z)

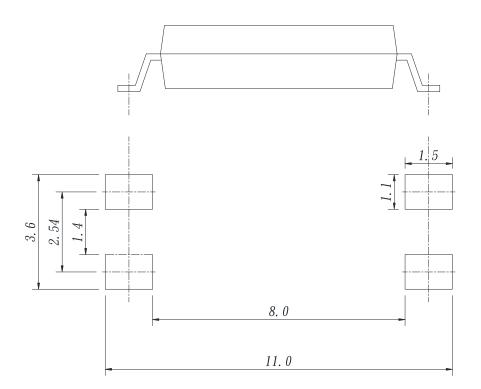
Notes:

KT1410 = Part No.

Z = Tape and reel option (TLD \ TRU)

Option	Description	Packing quantity		
TLD	TLD tape & reel option	3000 units per reel		
TRU	TRU tape & reel option	3000 units per reel		

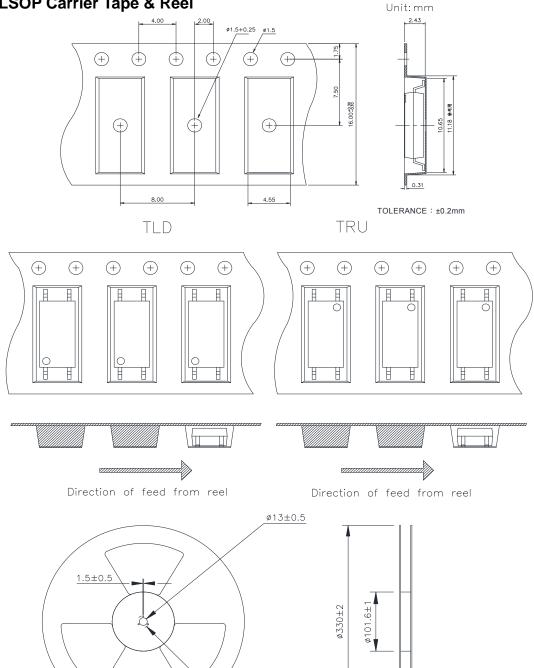
• Recommended Pad Layout for Surface Mount Lead Form



Unit: mm

4PIN LSOP PHOTODARLINGTON PHOTOCOUPLER

• 4-pin LSOP Carrier Tape & Reel



2±0.2

ø20.2±1

cosmo

KT1410 Series 4PIN LSOP PHOTOCOUPLER PHOTOCOUPLER

Application Notice

The statements regarding the suitability of products for certain types of applications are based on cosmo's knowledge of general applications of cosmo products. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to verify the specifications are suitable for use in a particular application. Customers are solely responsible for all aspects of their own product design or applications. The parameters provided in the datasheet may vary in different applications and performance may vary over time. All operating parameters (including typical parameters) must be validated by customer's technical experts for different applications. cosmo assumes no liability for customer' product design or applications. Product specifications do not expand or otherwise change cosmo's terms and conditions of purchase, including but not limited to the warranty expressed therein.

When using cosmo products, please comply with safety standards and instructions. cosmo has no liability and responsibility to the damage caused by improper use of the instructions specified in the specifications.

cosmo products are designed for use in general electronic equipment such as telecommunications, office automation equipments, personal computers, test and measurement equipments, consumer electronics, industrial control, instrumentation, audio, video.

cosmo devices shall not be used in equipment that requires higher level of reliability and safety, such as nuclear power control equipment, telecommunication equipment(trunk lines), space application, medical and other life supporting equipments, and equipment for aircraft, military, automotive or any other application that can cause human injury or death.

cosmo reserves the right to change the specifications, data, characteristics, structure, materials and other contents at any time without notice. Please contact cosmo to obtain the latest specification.

cosmo disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.